BTM4504C1H Bluetooth Module

Rev 2.4

FCC ID:SI8-BTM4504C1H



Chongqing Jinou Science and Technology Development Co., Ltd. website: www.jinoux.com

Contents

1.	Fea	tures2
2.	Pro	duct Description2
3.	App	lications2
4.	Blo	ck Diagram2
5.	Pin	Descriptions
	5.1	Device Terminal
	5.2	Device Terminal Functions
6.	Ele	ctrical Specifications4
	6.1	Input/Output Terminal Characteristics
	6.2	Auxilliary ADC
	6.3	Absolute Maximum ratings5
	6.4	Power Consumption (Don' t use AP)5
7.	Rad	io Characteristics - Basic Data Rate5
	7.1	Transmitter
	7.2	Receiver
8.	UAR	T Interface7
	8.1	UART Bypass9
	8.2	UART Configuration While RESET is Active9
	8.3	UART Bypass Mode9
	8.4	Current Consumption in UART Bypass Mode9
9.	I/0	Parallel Ports9
10.	RES	ETB10
	10.1	Pin States on Reset10
	10.2	Status after Reset10
11.	Sol	der Profiles11
12.	Phy	sical Dimensions12
13.	Gui	de for Antenna Radiation13



Bluetooth Module Class 1

1. Features

- 1.1 Operating Frequency Band 2.40 GHz².48GHz unlicensed ISM Band
- 1.2 Class 1 type Output Power ${\leqslant}20~\mathrm{dBm}$; Antenna gain ${\leqslant}1.5\mathrm{dBi}$
- 1.3 UART Host Interface
- 1.4 Low Voltage Power Supply, 2.7V to 3.6V
- 1.5 Nominal Supply Voltage at 3.3 ± 0.1 V
- 1.6 Low Power Modes Available: Park, Sniff, Hold and Deep Sleep
- 1.7 Size: 27.3mm×14.5 (unit: mm Error = ± 0.2 mm)

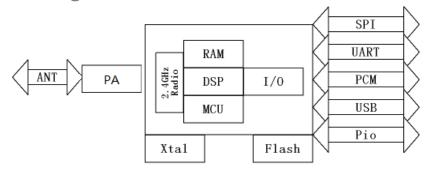
2. Product Description

The BC04 Bluetooth Module (BTM4504C1H) is a Class 1 Bluetooth module using BlueCore4-External chipset from leading Bluetooth chipset supplier, Cambridge Silicon Radio. It provides a fully compliant Bluetooth system for data and voice communications. Interfaces with a host via USB or UART and support full data rate up to 3Mbps modulation modes. Voice interface supported PCM protocol. The module and device firmware is fully compliant with the Bluetooth specification v3.0.

3. Applications

- 3.1 PCs, PDAs
- 3.2 Computer Accessories (CF Cards, USB DonglesPCMCIA, RS232 Adaptors, etc.)
- 3.3 Mice, Keyboard, Joysticks
- 3.4 Cordless Phone
- 3.5 FAX, Printer Adaptors
- 3.6 Digital Camera
- 3.7 Access Points to LAN and/or Dial-up network

4. Block Diagram



5. Pin Descriptions

5.1	Device Termin	al			
No.	Des	37	38	Des	No.
		GND	GND		
36	GND			ANT	1
35	GND	37	38 1 T	GND	2
34	GND			Pio2	3
33	GND	 	N 1.5 O 17	Pio3	4
32	Aio0		3 :1	Pio4	5
31	Aio1	 	2 3 	Pio5	6
30	RESET			Pio6	7
29	SPI-MISO		:_[Pio7	8
28	SPI-CSB			Pio8	9
27	SPI-CLK		1	Pio9	10
26	SPI-MOSI	1		Pio10	11
25	UART-CTS	1		Pio11	12
24	UART-TX			USB-DN	13
23	UART-RTS			USB-DP	14
22	UART-RX			PCM-CLK	15
21	Vref-Filter			PCM-IN	16
20	Vcc		·	PCM-SYN	17
19	GND			PCM-OUT	18
		F 5			
		F;			

5.2 Device Terminal Functions

PIN	NAME	TYPE	DESCRIPTION
1	ANT	Analogue	Single ended receiver input
24	UART_TX	CMOS output, tri-state, with weak internal pull-up	UART data output
22	UART_RX	CMOS input with weak internal pull-down	UART data input
23	UART_RTS	CMOS output, tri-state, with weak internal pull-up	UART request to send active low
25	UART_CTS	CMOS input with weak internal pull-down	UART clear to send active low
14	USB_DP	Bi-directional	USB data plus with selectable internal 1.5k. pull-up resistor
13	USB_DN	Bi-directional	USB data minus
18	PCM_OUT	CMOS output, tri-state, with weak internal pull-down	Synchronous data output
16	PCM_IN	CMOS input, with weak internal pull-down	Synchronous data input
17	PCM_SYN	Bi-directional with weak internal pull-down	Synchronous data sync
15	PCM_CLK	Bi-directional with weak internal pull-down	Synchronous data clock
	1		
3	Pio2	Bi-directional with programmable	Programmable Input/Output Line

	T	1	1		
		strength internal pull-up/down			
4	Pio3	Bi-directional with programmable	Programmable Input/Output Line		
1	1100	strength internal pull-up/down			
		Bi-directional with programmable	Programmable input/output line or		
5	Pio4	strength internal pull-up/down	Optionally BT_Priority/Ch_Clk output		
		berengen internar part ap, aomi	for co-existence signalling		
		Bi-directional with programmable	Programmable input/output line or		
6	Pio5	strength internal pull-up/down	Optionally BT_Active output for		
		berengen internar part op, som	co-existence signalling		
		Bi-directional with programmable	Programmable input/output line or		
7	Pio6	strength internal pull-up/down	Optionally WLAN_Active/Ch_Data input		
			for co-existence signalling		
8	Pio7	Bi-directional with programmable	Programmable Input/Output Line		
		strength internal pull-up/down			
9	Pio8	Bi-directional with programmable	Programmable Input/Output Line		
		strength internal pull-up/down			
10	Pio9	Bi-directional with programmable	Programmable Input/Output Line		
		strength internal pull-up/down			
11	Pio10	Bi-directional with programmable	Programmable Input/Output Line		
		strength internal pull-up/down			
12	Pio11	Bi-directional with programmable	Programmable Input/Output Line		
0.0	A: 0	strength internal pull-up/down			
32	AioO	Bi-directional	Programmable input/output line		
31	Aiol	Bi-directional	Programmable input/output line		
			internal pull-up Reset if low. Input		
30	RESET	CMOS input with week internel pull up	debounced so must be low for >5ms to		
30	KESE I	CMOS input with weak internal pull-up	cause a reset		
			Chip select for Synchronous Serial		
28	SPI_CSB	CMOS input with weak internal pull-up	Interface active low		
		CMOS input with weak internal			
27	SPI_CLK	pull-down	Serial Peripheral Interface clock		
		CMOS input with weak internal	Serial Peripheral Interface data		
26	SPI_MOSI	pull-down	input		
		CMOS output, tri-state, with weak	Serial Peripheral Interface data		
29	SPI_MISO	internal pull-down	output		
	I	incontai part dont			
21	Vref-Filter		Filter Capacitor for 1.8V		
20	Vcc	Power Supply	+3.3V Power Supply.		
	GND	(0ther)	Ground		
		· · · · ·	1		

6. Electrical Specifications

6.1 Input/Output Terminal Characteristics

Digital Terminals	Min	Тур	Max	Unit
Input Voltage Levels				
VIL input logic level low 2.7V \leq Vcc \leq 3.0V	-0.4	_	+0.8	V
VIH input logic level high	0.7Vcc	_	Vcc+0.4	V
Output Voltage Levels				
VOL output logic level low			0.2	V
$(1o = 4.0 \text{mA}), 2.7 \text{V} \leq \text{Vcc} \leq 3.0 \text{V}$			0.2	v
VOH output logic level high	Vcc-0.2	_	_	V
$(1o = -4.0 \text{mA}), 2.7 \text{V} \leq \text{Vcc} \leq 3.0 \text{V}$	VCC-0.2		_	v
Input and Tri-state Current with				
Strong pull-up	-100	-40	-10	μA
Strong pull-down	+10	+40	+100	μA
Weak pull-up	-5.0	-1.0	-0.2	μA
Weak pull-down	+0.2	+1.0	+5.0	μA

I/O pad leakage current	-1	0	+1	μA
CI Input Capacitance	1.0	_	5.0	pF

6.2 Auxilliary ADC

Auxiliary ADC	Min	Тур	Max	Unit
Resolution	_	_	8	Bits
Input voltage range (LSB size = Vref/255)	0	-	Vref	V
Accuracy INL (Guaranteed monotonic)	-1	-	1	LSB
Accuracy DNL (Guaranteed monotonic)	0	_	1	LSB
Offset	-1	_	1	LSB
Gain Error	-0.8	_	0.8	%
Input Bandwidth	-	100	I	kHz
Conversion time	_	2.5	_	μs
Sample rate(a)	_	_	700	Samples/s

6.3 Absolute Maximum ratings

Absolute maximum ratings for supply voltage and voltages on digital and analogue pins of the Module are listed below; exceeding these values will cause permanent damage.

Parameter	Min	Max	Unit
Peak current of power supply	0	75	mA
Voltage at digital pins	-0.3	3.6	V
Voltage at POWER pin	2.7	3.6	V

Connection UART Rate Operation Mode Average Unit Type (kbps) 0.42 Page scan 115.2 mA — _ 0.76 Inquiry and page scan 115.2 mА 4.60 ACL No traffic Master 115.2 mA ACL With file transfer 115.2 10.3 Master mА ACL No traffic Slave 115.2 17.0 mA ACL With file transfer Slave 24.7 115.2 mA ACL 40ms sniff Master 38.4 2.40 mА ACL 1.28s sniff 0.37 Master 38.4 mA SCO HV1 Master 38.4 39.2 mA SCO HV3 Master 38.4 20.3 mΑ SCO HV3 30ms sniff Master 38.4 19.8 mА ACL 40ms sniff Slave 38.4 2.11 mА ACL 1.28s sniff S1ave 38.4 0.42 mA Parked 1.28s beacon Slave 81 38.4 0.20 mА SCO HV1 Slave 38.4 39.1 mА 38.4 SCO HV3 Slave 24.8 mΑ SCO HV3 30ms sniff 38.4 19.0 S1ave mΑ Standby Host connection(a) _ 38.4 40 uA Reset (RESETB low) (a) 34 uA

6.4 Power Consumption (Don' t use AP)

(a) Low power mode on the linear regulator is entered and exited automatically when the chip enters/leaves Deep Sleep mode .

(b) Add 0 \sim 100mA if use AP.

7. Radio Characteristics - Basic Data Rate Important Notes BlueCore4 meets the Bluetooth v3.0 + EDR specification when used in a suitable application circuit between $-40\,^\circ$ C and $+105\,^\circ$ C.

Tx output is guaranteed to be unconditionally stable over the guaranteed temperature range.

7.1 Transmitter

Radio Characteristics Vcc = 3.3V Temperature = $+20^{\circ}$ C

	Min	Тур	Max	Bluetooth Specification	Unit
Maximum RF transmit power ⁽¹⁾⁽²⁾	-	15	-	0 to $+20^{(3)}$	dBm
Variation in RF power over temperature range with compensation enabled $(\pm)^{\rm \scriptscriptstyle (4)}$	-	1.5	_	-	dB
Variation in RF power over temperature range with compensation disabled $(\pm)^{\scriptscriptstyle (4)}$	-	2	_	_	dB
RF power control range	1	35	_	≥16	dB
RF power range control resolution (5)	1	0.5	-	-	dB
20dB bandwidth for modulated carrier	1	780	_	≤1000	kHz
Adjacent channel transmit power F=F0 ± 2 MHz $^{^{(6)}(7)}$	-	-40	-	≤-20	dBm
Adjacent channel transmit power F=F0 $\pm 3 \mathrm{MHz}^{^{\mathrm{(6)}(7)}}$	I	-45	-	≤-40	dBm
Adjacent channel transmit power F=F0> \pm 3MHz $^{^{(6)}(7)}$	-	-50	-	≤-40	dBm
Δ flavg .Maximum Modulation.	I	165	-	140<	kHz
				∆ f1avg <175	
Δ f2max .Minimum Modulation.	-	150	-	≥115	kHz
Δf2avg / Δf1avg	-	0.97	-	≥0.80	-
Initial carrier frequency tolerance	-	6	-	± 75	kHz
Drift Rate	-	8	_	≤20	kHz /50µ S
Drift (single slot packet)	-	7	-	≤25	kHz
Drift (five slot packet)	_	9	_	≪40	kHz
2 nd Harmonic content	-	-65	-	≤-30	dBm
3 rd Harmonic content	-	-45	-	≪-30	dBm

Notes:

(1) BlueCore4 firmware maintains the transmit power to be within the Bluetooth v3.0 + EDR specification limits.

(2) Measurement made using a PSKEY_LC_MAX_TX_POWER setting corresponds to a PSKEY_LC_POWER_TABLE power table entry of 63.

(3) Class 1 RF transmit power range, Bluetooth v3.0 + EDR specification.

(4) To some extent these parameters are dependent on the matching circuit used, and its behaviour over temperature. Therefore these parameters may be beyond CSR's direct control.

(5) Resolution guaranteed over the range -5dB to -25dB relative to maximum power for Tx Level >20.

(6) Measured at FO= 2441MHz.

(7) Up to three exceptions are allowed in the Bluetooth v3.0 + EDR specification. BlueCore4 is guaranteed to meet the ACP performance as specified by the Bluetooth v3.0 + EDR specification.

7.2 Receiver

Radio Characteristics Vcc = 3.3V Temperature = $+20^{\circ}$ C

	Frequency (GHz)	Min	Тур	Max	Bluetooth Specification	Unit
Separativity at 0 1% DED	2.402	-	-84			
Sensitivity at 0.1% BER for all packet types	2.441	-	-84		≪-70	dBm
Tor all packet types	2.480	-	-85	-		
Maximum received signal a	t 0.1% BER	-	10		≤-20	dBm
	Frequency (GHz)	Min	Тур	Max	Bluetooth Specification	Unit

Continuous power required to block	30 - 2000	-	TBD	_	≪-10	
Bluetooth reception (for sensitivity of	2000 - 2400	-	TBD	-	≤-27	dBm
-67dBm with 0.1% BER) measured at the	2500 - 3000	-	TBD	-	≤-27	UDIII
unbalanced port of the balun.	3000 - 3300	-	TBD	-	≤-10	
C/I co-channel		-	6	-	≤11	dB
Adjacent channel selectivity C/I	$F=F0 +1MHz^{(1)}$	-	-5	-	$\leqslant 0$	dB
Adjacent channel selectivity C/I	$F = F0 - 1 MHz^{(1)}$	-	-4	-	$\leqslant 0$	dB
Adjacent channel selectivity C/I	$F=F0 +2MHz^{(1)}$	-	-38	-	≤-30	dB
Adjacent channel selectivity C/I	$F=F0 -2MHz^{(1)}$	-	-23	-	≤-20	dB
Adjacent channel selectivity C/I	$F \ge F0 + 3MHz^{(1)}$	-	-45	-	≪-40	dB
Adjacent channel selectivity C/I	$F \le F0 -5MHz^{(1)}$	-	-44	-	≪-40	dB
Adjacent channel selectivity C/I F=FImage $^{(1)}$		-	-22	-	≪-9	dB
Maximum level of intermodulation interferers (3)		-	-30	—	≥-39	dBm
Spurious output level (4)		-	TBD	—	-	dBm/Hz

Notes:

(1) Up to five exceptions are allowed in the Bluetooth v3. 0 + EDR specification. BlueCore4 is guaranteed to meet the C/I performance as specified by the Bluetooth v3. 0 + EDR specification.

(2) Measured at F0 = 2441 MHz

(3) Measured at f1-f2 = 5MHz. Measurement is performed in accordance with Bluetooth RF test RCV/CA/05/c. i.e. wanted signal at -64dBm

(4) Measured at the unbalanced port of the balun. Integrated in 100kHz bandwidth and then normalized to 1Hz. Actual figure is typically below TBD dBm/Hz except for peaks of -52dBm inband at 2.4GHz and ≤ 80 dBm at 3.2GHz

8. UART Interface

BlueCore4-External Universal Asynchronous Receiver Transmitter (UART) interface provides a simple mechanism for communicating with other serial devices using the RS232 standard $^{(1)}$.

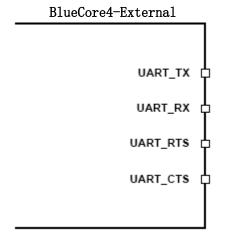


Figure 11.12: Universal Asynchronous Receiver

Four signals are used to implement the UART function, as shown in Figure 11.12. When BlueCore4-External is connected to another digital device, UART_RX and UART_TX transfer data between the two devices. The remaining two signals, UART_CTS and UART_RTS, can be used to implement RS232 hardware flow control where both are active low indicators. All UART connections are implemented using CMOS technology and have signalling levels of OV and Vcc.

UART configuration parameters, such as Baud rate and packet format, are set using BlueCore4-External software.

Notes:

In order to communicate with the UART at its maximum data rate using a standard PC, an accelerated serial port adapter card is required for the PC.

(1) Uses RS232 protocol but voltage levels are OV to VDD_USB, (requires external RS232 transceiver chip)

Para	Possible Values		
	Minimum	1200 Baud (≤2%Error)	
Baud Rate	MITTIUIII	9600 Baud (≤1%Error)	
	3.0MBaud (≤1%Error)		
Flow Control	RTS/CTS or None		
Parity	Parity		
Number of Stop Bits	1 or 2		
Bits per channel	8		

Table 11.7: Possible UART Settings

The UART interface is capable of resetting BlueCore4-External upon reception of a break signal. A Break is identified by a continuous logic low (OV) on the UART_RX terminal, as shown in Figure 11.13. If tBRK is longer than the value, defined by the PS Key PSKEY_HOST_IO_UART_RESET_TIMEOUT, (0x1a4), a reset will occur.

This feature allows a host to initialise the system to a known state. Also, BlueCore4-External can emit a Break character that may be used to wake the Host.



Note:

The DFU boot loader must be loaded into the Flash device before the UART or USB interfaces can be used. This initial flash programming can be done via the SPI.

Table 11.3 shows a list of commonly used Baud rates and their associated values for the Persistent Store Key PSKEY_UART_BAUD_RATE (0x204). There is no requirement to use these standard values. Any Baud rate within the supported range can be set in the Persistent Store Key according to the formula in Equation 11.7.

Baud Rate = PSKEY_UART_BAUD_RATE / 0.004096

Equation 11.7: Baud Rate

Baud Rate	Persistent Store Value		Emer
	Hex	Dec	Error
1200	0x0005	5	1.73%
2400	0x000a	10	1.73%
4800	0x0014	20	1.73%
9600	0x0027	39	-0.82%
19200	0x004f	79	0.45%
38400	0x009d	157	-0.18%
57600	0x00ec	236	0.03%
76800	0x013b	315	0.14%
115200	0x01d8	472	0.03%
230400	0x03b0	944	0.03%
460800	0x075f	1887	-0.02%
921600	0x0ebf	3775	0.00%
1382400	0x161e	5662	-0.01%
1843200	0x1d7e	7550	0.00%
2764800	0x2c3d	11325	0.00%

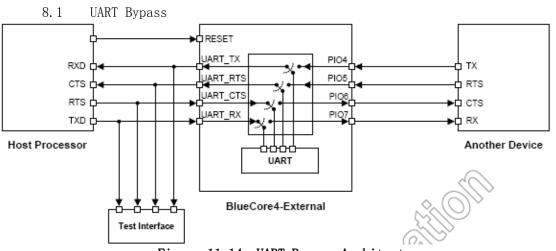


Table 11.8: Standard Baud Rates

Figure 11.14: UART Bypass Architecture

8.2 UART Configuration While RESET is Active

The UART interface for BlueCore4-External while the chip is being held in reset is tri-state. This will allow the user to daisy chain devices onto the physical UART bus. The constraint on this method is that any devices connected to this bus must tri-state when BlueCore4-External reset is de-asserted and the firmware begins to run.

8.3 UART Bypass Mode

Alternatively, for devices that do not tri-state the UART bus, the UART bypass mode on BlueCore4-External can be used. The default state of BlueCore4-External after reset is de-asserted, this is for the host UART bus to be connected to the BlueCore4-External UART, thereby allowing communication to BlueCore4-External via the UART.

In order to apply the UART bypass mode, a BCCMD command will be issued to BlueCore4-External upon this, it will switch the bypass to PIO[7:4] as shown in Figure 11.14. Once the bypass mode has been invoked, BlueCore4-External will enter the deep sleep state indefinitely.

In order to re-establish communication with BlueCore4-External, the chip must be reset so that the default configuration takes affect.

It is important for the host to ensure a clean Bluetooth disconnection of any active links before the bypass mode is invoked. Therefore it is not possible to have active Bluetooth links while operating the bypass mode.

8.4 Current Consumption in UART Bypass Mode

The current consumption for a device in UART Bypass Mode is equal to the values quoted for a device in standby mode.

9. I/O Parallel Ports

Fifteen lines of programmable bi-directional input/outputs (I/O) are provided. PIO[11:8] and PIO[3:0] are powered from Vcc. PIO[7:4] are powered from Vcc. AIO [2:0] are powered from Vref.

PIO lines can be configured through software to have either weak or strong pull-ups or pull-downs. All PIO lines are configured as inputs with weak pull-downs at reset.

PIO[0] and PIO[1] are normally dedicated to RXEN and TXEN respectively, but they are available for general use.

Any of the PIO lines can be configured as interrupt request lines or as wake-up lines from sleep modes. PIO[6] or PIO [2] can be configured as a request line for an external clock source. This is useful when the clock to BlueCore4-External is provided from a

system application specific integrated circuit (ASIC).

BlueCore4-External has three general purpose analogue interface pins, AIO[0], AIO[1] and AIO[2]. These are used to access internal circuitry and control signals. One pin is allocated to decoupling for the on-chip band gap reference voltage, the other three may be configured to provide additional functionality.

Auxiliary functions available via these pins include an 8-bit ADC and an 8-bit DAC. Typically the ADC is used for battery voltage measurement. Signals selectable at these pins include the band gap reference voltage and a variety of clock signals; 48, 24, 16, 8MHz and the XTAL clock frequency. When used with analogue signals the voltage range is constrained by the analogue supply voltage (1.8V). When configured to drive out digital level signals (clocks) generated from within the analogue part of the device, the output voltage level is determined by Vref (1.8V).

Important Note:

CSR cannot guarantee that terminal functions PIOs remain the same. Please refer to the software release note for the implementation of these PIO lines, as they are firmware build specific.

10. RESETB

BlueCore4 Module may be reset from several sources: power on reset, a UART break character or via a software configured watchdog timer.

The power on reset occurs when the VDD_CORE supply falls below typically 1.5V and is released when VDD_CORE rises above typically 1.6V.

At reset the digital I/O pins are set to inputs for bi-directional pins and outputs are tri-stated. The PIOs have weak pull-downs.

Following a reset, BlueCore4-External assumes the maximum XTAL_IN frequency, which ensures that the internal clocks run at a safe (low) frequency until BlueCore4-External is configured for the actual XTAL_IN frequency. If no clock is present at XTAL_IN, the oscillator in BlueCore4-External free runs, again at a safe frequency.

Pin Name	State: BlueCore4-External
PI0[6:2]	Input with weak pull-down
UART_TX	Output tri-stated with weak pull-up
UART_RX	Input with weak pull-down
UART_RTS	Output tri-stated with weak pull-up
UART_CTS	Input with weak pull-down
SPI_CSB	Input with weak pull-up
SPI_CLK	Input with weak pull-down
SPI_MOSI	Input with weak pull-down
SPI_MISO	Output tri-stated with weak pull-down
AIO[1]	Output, driving low

10.1 Pin States on Reset

Table 11.15 shows the pin states of BlueCore4-External on reset.

Table 11.15: Pin States of BlueCore4-External on Reset

10.2 Status after Reset

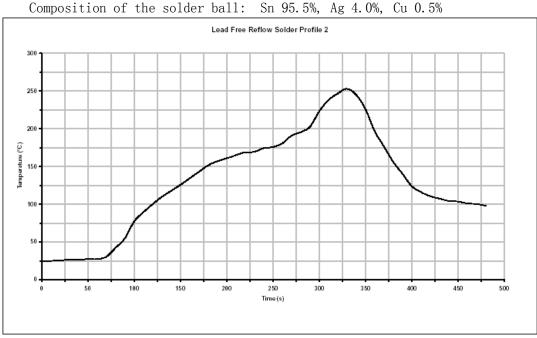
The chip status after a reset is as follows:

- Warm Reset: Baud rate and RAM data remain available
- Cold Reset(1): Baud rate and RAM data not available

Note:

- (1) Cold Reset constitutes one of the following:
 - Power cycle
 - System reset (firmware fault code)

11. Solder Profiles



Typical Lead-Free Re-flow Solder Profile

Key features of the profile:

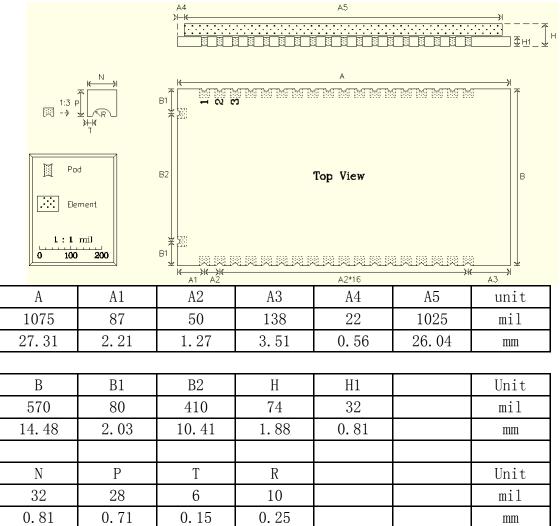
• Initial Ramp = 1-2.5° C/sec to 175° C±25° C equilibrium

- Equilibrium time = 60 to 180 seconds
- Ramp to Maximum temperature (250° C) = 3° C/sec max.
- Time above liquidus temperature (217°C): 45-90 seconds
- Device absolute maximum reflow temperature: 260° C

Devices will withstand the specified profile. Lead-free devices will withstand up to three reflows to a maximum temperature of 260° C.

Notes: They need to be baked prior to mounting.

12. Physical Dimensions



while L > 100mil Error = ± 10 mil, while L<= 100mil Error = $\pm 10\%$

13. Guide for Antenna Radiation

In order to achieve longest communication range, please keep the area surrounding antenna free of grounding or metal housing.

Modular Approval:

The BTM4504C1H module is designed to comply with the FCC statement. FCC ID is SI8BTM4504C1H. The host system using BTM4504C1H, should have label indicated it contain modular's FCC ID SI8BTM4504C1H.

*RF warning for Mobile device:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with minimum distance 20cm between the radiator & your body.

§ 15.19 Labelling requirements.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

§ 15.21 Information to user.

Any Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

§ 15.105 Information to the user.

Note: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by

turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

-Reorient or relocate the receiving antenna.

-Increase the separation between the equipment and receiver.

-Connect the equipment into an outlet on a circuit different from that to which the

receiver is connected.

-Consult the dealer or an experienced radio/TV technician for help.

the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed

IMPORTANT NOTE: In the event that these conditions cannot be met (for example certain laptop configurations or co-location with another transmitter), then the FCC authorization is no longer considered valid and the FCC ID can not be used on the final product. In these circumstances, the OEM integrator will be responsible for reevaluating the end product (including the transmitter) and obtaining a separate FCC authorization.

Manual Information To the End User

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module.

Chongqing Jinou Science & Technology Development Co., Ltd. Address: D1-802, Overseas Students Pioneer Park, No.71 Kecheng Rd, Jiulongpo District, 400039, Chongqing Tel: 86-23-68903066/68842136 Fax: 86-23-68644164 mail: <u>yf@jinoux.com</u> <u>jinou-lisa@foxmail.com</u> <u>whf@jinoux.com</u> website: <u>www.jinoux.com</u>